3-CHANNEL SIN/COS PHOTOSENSOR ARRAY



Rev D1, Page 1/9

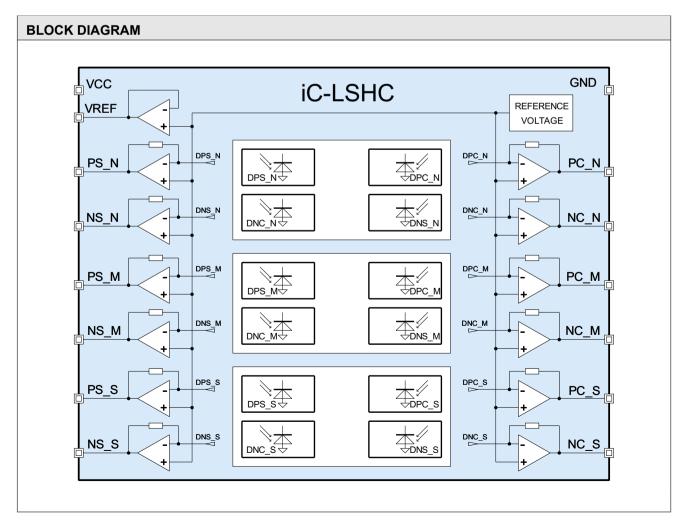
FEATURES

- Monolithic array of independent photosensors with excellent matching
- ♦ Compact photosensor size of 800 µm x 330 µm enabling smaller encoder systems
- ♦ Moderate alignment tolerance due to a track pitch of 1.08 mm
- ♦ Ultra low dark currents for operation to high temperature
- \blacklozenge Low noise amplifiers with high transimpedance of typ. 1 $\mbox{M}\Omega$
- ♦ Short-circuit-proof, low impedance voltage outputs for enhanced EMI tolerance
- ♦ Low power consumption from single 4.1 to 5.5 V supply
- ♦ Operational temperature range of -40 °C to +125 °C
- Space saving optoQFN and optoBGA packages (RoHS compliant)
- ♦ Available options
 - reticle assembly, code discs
 - customized COB modules

APPLICATIONS

- Optical position encoding from analog sine/cosine signals
- Absolute position encoders using nonius scales





3-CHANNEL SIN/COS PHOTOSENSOR ARRAY



Rev D1, Page 2/9

DESCRIPTION

The iC-LSHC photosensor is a general purpose optoelectronic scanner made to suit a variety of encoding applications, such as rotary and linear encoders used for motion control, robotics, brushless DC motor commutation, power tools etc.

iC-LSHC features 12 monolithically integrated photosensors with active areas of 800 μm x 330 μm each. A high transimpedance gain of typically 1 $M\Omega$ generates output signals of a few hundret Millivolts already from illumination levels of typ. 1.7 mW/cm². In most cases no additional measures must be considered to filter for noise and interferences.

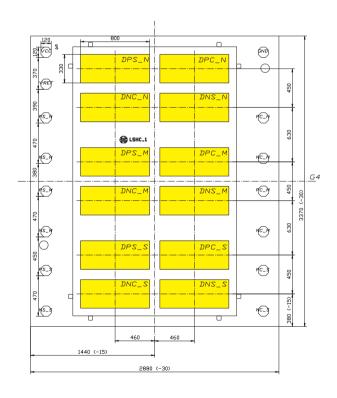
Sine/cosine encoders are the typical application for iC-LSHC. Its 3-track scanning features a set of 4 pho-

tosensors each per track, generating positive and negative going sine signals, as well as positive and negative going cosine signals. An excellent matching and common mode behavior of the differential signal paths is obtained by a paired amplifier design, reducing the needs for external signal calibration to an absolute minimum.

The spectral sensitivity range includes visible to near infrared light, with the maximum sensitivity being close to a wavelength of 680 nm. When using iC-LSHC for encoder applications with typical disc and mask codes, a signal amplitude of approximately some 100 mV is typical under low light conditions, for instance when iC-LSHC is illuminated at only 3.0 mW/cm² by an 740 nm LED.

PACKAGING INFORMATION

PAD LAYOUT



PAD FUNCTIONS No. Name Function

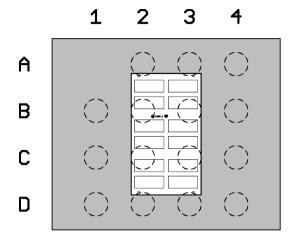
Refer to the description of pin functions. Note: Dimension G4 is the reference radius of the chip center.

3-CHANNEL SIN/COS PHOTOSENSOR ARRAY



Rev D1, Page 3/9

PIN CONFIGURATION oBGA LSH2C (6.2 mm x 5.2 mm)



PIN FUNCTIONS

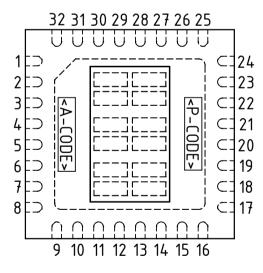
No. Name Function

A2 VCC +4.1...5.5 V Supply Voltage A3 VREF Reference Voltage Output A4 GND Ground B1 PS N N-Track Sine + B2 NS N N-Track Sine -B3 NC N N-Track Cosine -B4 PC N N-Track Cosine + C1 PS M M-Track Sine + C2 NS M M-Track Sine -C3 NC M M-Track Cosine -C4 PC M M-Track Cosine + D1 PS S S-Track Sine + D2 NS_S S-Track Sine -D3 NC S S-Track Cosine -D4 PC S S-Track Cosine +

NB: All outputs supply analog voltages.

For dimensional specifications refer to the relevant package data sheet, available separately.

PIN CONFIGURATION oQFN32-5x5 (5 mm x 5 mm)



PIN FUNCTIONS

No.	Name	Function
1	VCC	+4.15.5 V Supply Voltage
2	VREF	Reference Voltage Output
3	PS_N	N-Track Sine +
4	NS_N	N-Track Sine -
5	PS_M	M-Track Sine +
6	NS_M	M-Track Sine -
		S-Track Sine +
		S-Track Sine -
9-16	n.c. ¹⁾	
17	NC_S	S-Track Cosine -
18	PC_S	S-Track Cosine +
19	NC_M	M-Track Cosine -
20	PC_M	M-Track Cosine +
21	NC_N	N-Track Cosine -
		N-Track Cosine +
23	n.c. ¹⁾	
24	GND	Ground
25-32		
	BP ²⁾	Backside paddle
		NB: All outputs supply analog volt-

ages.

IC top marking: <P-CODE> = product code, <A-CODE> = assembly code (subject to changes);

¹⁾ Pin numbers marked n.c. are not connected.

²⁾ Connecting the backside paddle is recommended by a single link to GND (use as shield). A current flow across the paddle is not permissible.

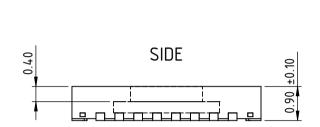
3-CHANNEL SIN/COS PHOTOSENSOR ARRAY

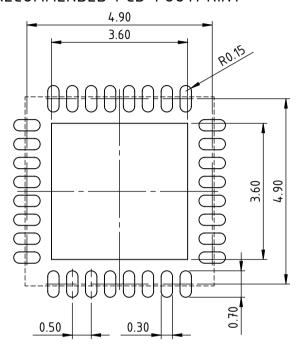


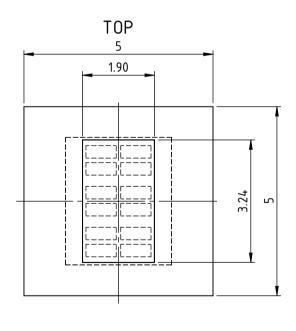
Rev D1, Page 4/9

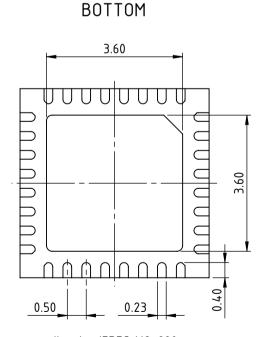
PACKAGE DIMENSIONS oQFN32-5x5

RECOMMENDED PCB-FOOTPRINT









All dimensions given in mm. Tolerances of form and position according to JEDEC M0-220. Tolerance of sensor pattern: ±70µm / ±1° (with respect to center of backside pad). Maximum molding excess +20µm / -75µm versus surface of glass/reticle.



Rev D1, Page 5/9

ABSOLUTE MAXIMUM RATINGS

These ratings do not imply operating conditions; functional operation is not guaranteed. Beyond these ratings device damage may occur.

Item	Symbol Parameter Conditions				Unit	
No.				Min.	Max.	
G001	VCC	Voltage at VCC		-0.3	6	V
G002	I(VCC)	Current in VCC		-20	20	mA
G003	V()	Pin Voltage, all signal outputs		-0.3	VCC + 0.3	V
G004	I()	Pin Current, all signal outputs		-20	20	mA
G005	Vd()	ESD Susceptibility, all pins	HBM, 100 pF discharged through 1.5 kΩ		2	kV
G006	Tj	Junction Temperature		-40	150	°C
G007	Ts	Chip Storage Temperature		-40	150	°C

THERMAL DATA

Operating conditions: VCC = 4.1 V . . . 5.5 V

Item	Symbol	Parameter	Conditions		0		Unit
No.				Min.	Тур.	Max.	
T01	Та	Operating Ambient Temperature Range	package oQFN32-5x5 package oBGA LSH2C	-40 -40		125 110	ပိ့
T02	Ts	Storage Temperature Range	package oQFN32-5x5 package oBGA LSH2C	-40 -40		125 110	ပံ့ပံ့
T03	Tpk	Soldering Peak Temperature	package oQFN32-5x5; tpk < 20 s, convection reflow tpk < 20 s, vapor phase soldering MSL 5A (max. floor life 24 h at 30 °C and 60 % RH); Please refer to customer information file No. 7 for details.			245 230	ος Ος
T04	Трк	Soldering Peak Temperature	package oBGA LSH2C tpk < 20 s, convection reflow tpk < 20 s, vapor phase soldering TOL (time on label) 8 h; Please refer to customer information file No. 7 for details.			245 230	°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°°

3-CHANNEL SIN/COS PHOTOSENSOR ARRAY



Rev D1, Page 6/9

ELECTRICAL CHARACTERISTICS

Operating conditions: VCC = 4.1...5.5 V, Tj = -40...125 °C, unless otherwise stated

ltem No.	Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Total	Device						
001	VCC	Permissible Supply Voltage		4.1		5.5	V
002	I(VCC)	Supply Current in VCC	no output load, photocurrents within linear operating range (no override)		9.5	15	mA
003	Vc()hi	Clamp-Voltage hi at all pins	I() = 4 mA			11	V
004	Vc()lo	Clamp-Voltage lo at all pins	I() = -4 mA	-1.2		-0.3	V
Photo	sensors						
101	λ ar	Spectral Application Range	$Se(\lambda ar) = 0.25 \times S(\lambda pk)$	400		950	nm
102	λ pk	Peak Sensitivity Wavelength			680		nm
103	Aph()	Radiant Sensitive Area	0.8 mm x 0.33 mm		0.264		mm ²
104	$S(\lambda)$	Spectral Sensitivity	$\begin{array}{l} \lambda_{\text{LED}} = 460 \text{nm} \\ \lambda_{\text{LED}} = 740 \text{nm} \\ \lambda_{\text{LED}} = 850 \text{nm} \end{array}$		0.30 0.45 0.30		A/W A/W A/W
106	E()mxr	Irradiance For Maximum Signal Level	λ_{LED} = 740 nm, Vout() not yet saturated		1.7		mW/ cm ²
Photo	current Am	plifiers					
201	lph()	Permissible Photocurrent Operating Range		0		1120	nA
202	η ()r	Photo Sensitivity (light-to-voltage conversion ratio)	λ_{LED} = 740 nm	0.2	0.3	0.5	V/µW
203	Z()	Equivalent Transimpedance Gain	Z = Vout() / lph()	0.7	1.0	1.4	ΜΩ
204	TCz	Temperature Coefficient of Transimpedance Gain			-0.12		%/°C
209	ΔZ()pn	Transimpedance Gain Matching	P vs. N path per diff. channel	-0.2		0.2	%
210	△Vout()pn	Signal Matching	no illumination, any output to any output	-35		35	mV
211	△Vout()pn	Signal Matching	no illumination, P output vs. corresponding N output	-2.5		2.5	mV
212	fc()hi	Cut-off Frequency (-3 dB)			400		kHz
213	VNoise()	RMS Output Noise	illuminated to 500 mV signal level above dark level, 500 kHz band width		0.5		mV
Signa	I Outputs						
301	Vout()mx	Permissible Maximum Output Voltage	illumination to E()mxr, linear gain; VCC = 4.55.5 V VCC = 4.1 V	2.4 2.0			V V
302	lout()mx	Permissible Max. Load Current		-100		250	μA
303	Vout()d	Dark Signal Level	no illumination, load 20 kΩ vs. +2 V	575	770	1000	mV
305	Isc()hi	Short-Circuit Current hi	load current to ground	100	420	1000	μA
306	Isc()lo	Short-Circuit Current lo	load current to IC	250	480	700	μA
307	Ri()	Internal Output Resistance	f= 1 kHz	70	110	180	Ω
308	ton()	Power-On Settling Time	$VCC = 0 V \rightarrow 5 V$			100	μs
Refer	ence Voltage	e VREF					
401	VREF	Reference Voltage	I(VREF) = -100+300 μA	575	770	1000	mV
402	dVout()	Load Balancing	I(VREF) = -100+300 μA	-10		+10	mV
403	lsc()hi	Short-Circuit Current hi	load current to ground	200	420	1400	μA
404	Isc()lo	Short-Circuit Current lo	load current to IC	0.4	4.5	10	mA



Rev D1, Page 7/9

APPLICATION CIRCUITS

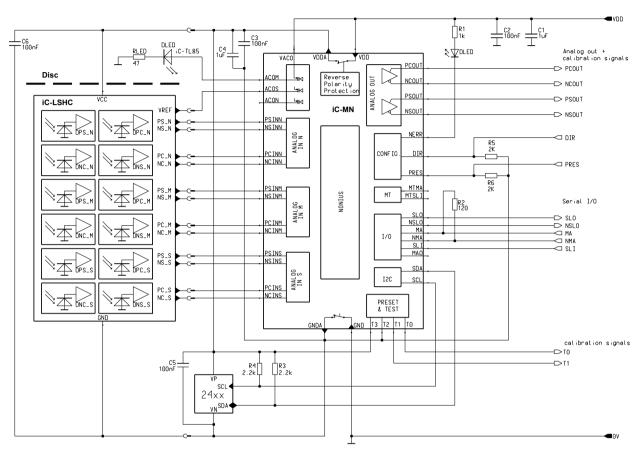


Figure 1: Application example of absolute encoder



Rev D1, Page 8/9

DESIGN REVIEW: Notes On Chip Functions

iC-LSHC 2					
No.	Function, Parameter/Code	Description and Application Hints			
1		Please refer to former datasheet release B1.			

Table 4: Notes on chip functions regarding iC-LSHC chip release 2.

iC-LSHC Z					
No.	Function, Parameter/Code	Description and Application Hints			
1		No further notes at time of printing.			

Table 5: Notes on chip functions regarding iC-LSHC chip release Z.

REVISION HISTORY

Rel.	Rel. Date ¹	Chapter	Modification	Page
D1	2017-08-03	FEATURES	Preliminary label removed Supply voltage extended to include 4.1 V Operational temperature up to 125 °C	1
		PACKAGING INFORMATION	oQFN with top marking, revision of footnote, update of oQFN package drawing	3, 4
		THERMAL DATA	Operating temperature up to 125 °C for oQFN	5
		ELECTRICAL CHARACTERISTICS	Operating conditions: VCC supply voltage extended to include 4.1 V Item 001: min. limit; item 101, condition: reference to λ pk Item 104: 460 nm supplemented Items 301, 303: conditions and limits (4.1 V added) Item 302: new item Item 304: removed Item 401: min. limit, item 403: max. limit	6
		APPLICATION CIRCUITS	Fig. 1 updated	7

iC-Haus expressly reserves the right to change its products and/or specifications. An Infoletter gives details as to any amendments and additions made to the relevant current specifications on our internet website www.ichaus.com/infoletter and is automatically generated and shall be sent to registered users by email. Copying – even as an excerpt – is only permitted with iC-Haus' approval in writing and precise reference to source.

The data specified is intended solely for the purpose of product description and shall represent the usual quality of the product. In case the specifications contain obvious mistakes e.g. in writing or calculation, iC-Haus reserves the right to correct the specification and no liability arises insofar that the specification was from a third party view obviously not reliable. There shall be no claims based on defects as to quality in cases of insignificant deviations from the specifications or in case of only minor impairment of usability.

No representations or warranties, either expressed or implied, of merchantability, fitness for a particular purpose or of any other nature are made hereunder with respect to information/specification or the products to which information refers and no guarantee with respect to compliance to the intended use is given. In particular, this also applies to the stated possible applications or areas of applications of the product.

iC-Haus products are not designed for and must not be used in connection with any applications where the failure of such products would reasonably be expected to result in significant personal injury or death (Safety-Critical Applications) without iC-Haus' specific written consent. Safety-Critical Applications include, without limitation, life support devices and systems. iC-Haus products are not designed nor intended for use in military or aerospace applications or environments or in automotive applications unless specifically designated for such use by iC-Haus.

iC-Haus conveys no patent, copyright, mask work right or other trade mark right to this product. iC-Haus assumes no liability for any patent and/or other trade mark rights of a third party resulting from processing or handling of the product and/or any other use of the product.

Software and its documentation is provided by iC-Haus GmbH or contributors "AS IS" and is subject to the ZVEI General Conditions for the Supply of Products and Services with iC-Haus amendments and the ZVEI Software clause with iC-Haus amendments (www.ichaus.com/EULA).

¹ Release Date format: YYYY-MM-DD



Rev D1, Page 9/9

ORDERING INFORMATION

Туре	Package	Options	Order Designation
iC-LSHC	15-pin optoBGA, 6.2 mm x 5.2 mm, thickness 1.7 mm RoHS compliant	glass lid	iC-LSHC oBGA LSH2C
	,	reticle 26-256 NMS	iC-LSHC oBGA LSH2C-4R
		reticle 26-1024 NMS	iC-LSHC oBGA LSH2C-1R
		custom reticle	iC-LSHC oBGA LSH2C-xxR
iC-LSHC	32-pin optoQFN, 5 mm x 5 mm, thickness 0.9 mm RoHS compliant	glass lid	iC-LSHC oQFN32-5x5
		custom reticle	iC-LSHC oQFN32-5x5-xxR
Code Discs		255/256/240 CPR OD Ø 26 mm, ID Ø 11.6 mm, optical radius 10.905 mm (glass 1 mm)	LSHC4S 26-256N
		1023/1024/992 CPR OD Ø 26 mm, ID Ø 11.6 mm, optical radius 10.905 mm (glass 1 mm)	LSHC1S 26-1024N

Please send your purchase orders to our order handling team:

Fax: +49 (0) 61 35 - 92 92 - 692 E-Mail: dispo@ichaus.com

For technical support, information about prices and terms of delivery please contact:

iC-Haus GmbH Tel.: +49 (0) 61 35 -92 92 -0
Am Kuemmerling 18 Fax: +49 (0) 61 35 -92 92 -192
D-55294 Bodenheim Web: http://www.ichaus.com
GERMANY E-Mail: sales@ichaus.com

Appointed local distributors: http://www.ichaus.com/sales_partners